

PRELIMINARY
 Notice: This is not a final specification.
 Some parametric limits are subject to change.

MITSUBISHI HVIGBT MODULES
CM800HB-66H

2nd-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

HIGH POWER SWITCHING USE
 INSULATED TYPE

CM800HB-66H



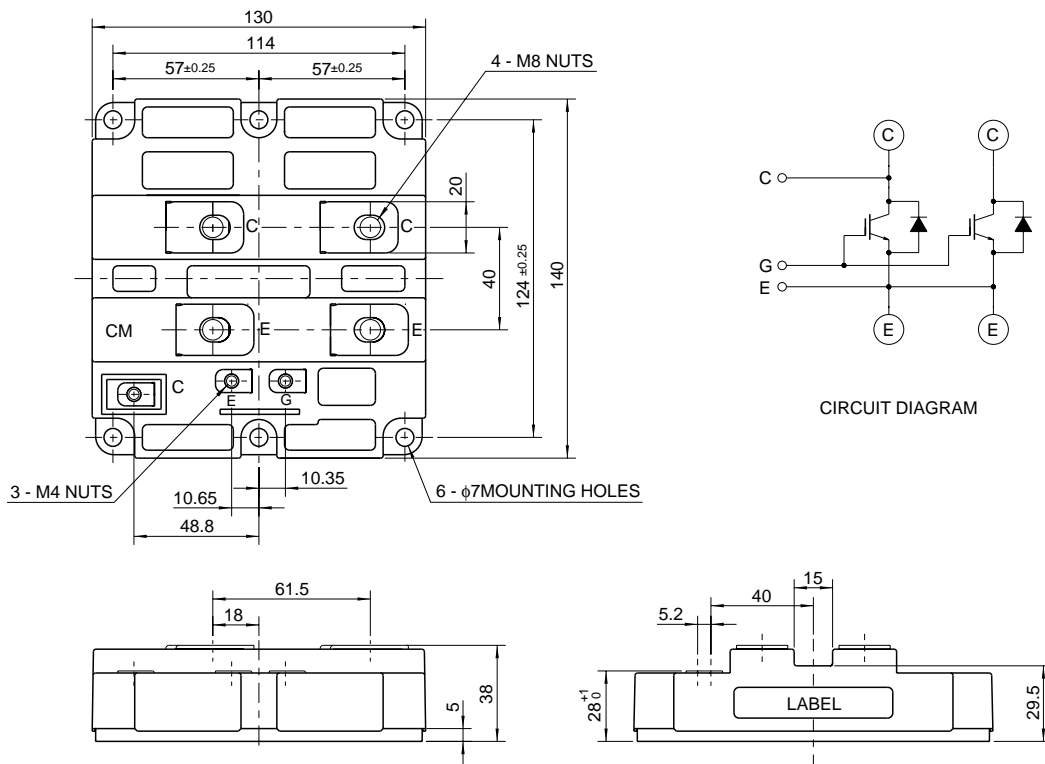
- IC.....800A
- VCES 3300V
- Insulated Type
- 1-element in a pack

APPLICATION

Inverters, Converters, DC choppers, Induction heating, DC to DC converters.

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



HVIGBT MODULES (High Voltage Insulated Gate Bipolar Transistor Modules)

Aug.1998

PRELIMINARY
 Notice: This is not a final specification.
 Some parametric limits are subject to change.

CM800HB-66H

**HIGH POWER SWITCHING USE
 INSULATED TYPE**

2nd-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

MAXIMUM RATINGS (T_j = 25°C)

Symbol	Parameter	Conditions	Ratings	Unit
V _{CES}	Collector-emitter voltage	G-E Short	3300	V
V _{GES}	Gate-emitter voltage	C-E Short	±20	V
I _C	Collector current	T _C = 25°C	800	A
I _{CM}		Pulse (Note 2)	1600	A
I _E (Note 1)	Emitter current	T _C = 25°C	800	A
I _{EM} (Note 1)		Pulse (Note 2)	1600	A
P _C (Note 3)	Maximum collector dissipation	T _C = 25°C	10420	W
T _j	Junction temperature	—	-40 ~ +150	°C
T _{stg}	Storage temperature	—	-40 ~ +125	°C
V _{iso}	Isolation voltage	Main terminal to Bass, AC for 1 minute	6000	V
—	Mounting torque	Main terminals screw M8	6.67 ~ 8.24	N·m
		Mounting screw M6	2.84 ~ 3.43	N·m
		Auxiliary terminals screw M4	0.88 ~ 1.08	N·m
—	Weight	Typical value	1.5	kg

ELECTRICAL CHARACTERISTICS (T_j = 25°C)

Symbol	Parameter	Test conditions	Limits			Unit
			Min	Typ	Max	
I _{CES}	Collector cutoff current	V _{CE} = V _{CES} , V _{GE} = 0V	—	—	10	mA
V _{GE(th)}	Gate-emitter threshold voltage	I _C = 80mA, V _{CE} = 10V	4.5	6.0	7.5	V
I _{GES}	Gate-leakage current	V _{GE} = V _{GES} , V _{CE} = 0V	—	—	0.5	µA
V _{CE(sat)}	Collector-emitter saturation voltage	T _j = 25°C	—	3.80	4.94	V
		T _j = 125°C	—	4.00	—	
C _{ies}	Input capacitance	V _{CE} = 10V	—	130	—	nF
C _{oes}	Output capacitance	V _{GE} = 0V	—	8.0	—	nF
C _{res}	Reverse transfer capacitance	f = 1MHz	—	3.6	—	nF
Q _G	Total gate charge	V _{CC} = 1650V, I _C = 800A, V _{GE} = 15V	—	10	—	µC
t _{d(on)}	Turn-on delay time	V _{CC} = 1650V, I _C = 800A	—	—	1.60	µs
t _r	Turn-on rise time	V _{GE1} = V _{GE2} = 15V	—	—	2.00	µs
t _{d(off)}	Turn-off delay time	R _G = 2.5Ω	—	—	2.50	µs
t _f	Turn-off fall time	Resistive load switching operation	—	—	1.00	µs
V _{EC} (Note 1)	Emitter-collector voltage	I _E = 800A, V _{GE} = 0V	—	2.80	3.64	V
t _{rr} (Note 1)	Reverse recovery time	I _E = 800A,	—	—	1.40	µs
Q _{rr} (Note 1)	Reverse recovery charge	die / dt = -1600A / µs (Note 1)	—	270	—	µC
R _{th(j-c)Q}	Thermal resistance	IGBT part	—	—	0.012	°C/W
R _{th(j-c)R}		FWDi part	—	—	0.024	°C/W
R _{th(c-f)}	Contact thermal resistance	Case to fin, conductive grease applied	—	0.008	—	°C/W

Note 1. I_E, V_{EC}, t_{rr}, Q_{rr} & die/dt represent characteristics of the anti-parallel, emitter to collector free-wheel diode.

2. Pulse width and repetition rate should be such that the device junction temp. (T_j) does not exceed T_{jmax} rating.

3. Junction temperature (T_j) should not increase beyond 150°C.

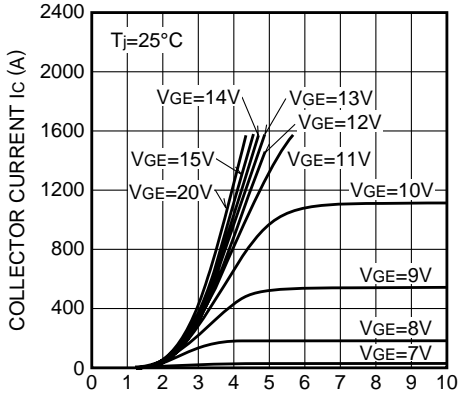
4. Pulse width and repetition rate should be such as to cause negligible temperature rise.

PRELIMINARY
 Notice: This is not a final specification.
 Some parametric limits are subject to change.

2nd-Version HVIGBT (High Voltage Insulated Gate Bipolar Transistor) Modules

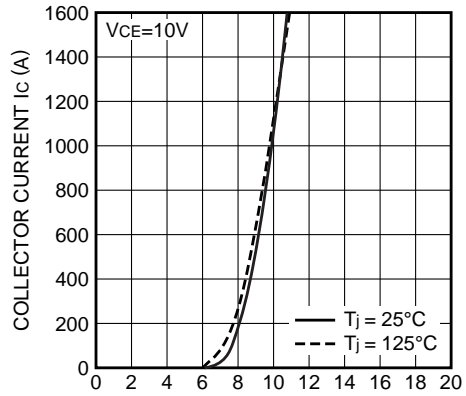
PERFORMANCE CURVES

OUTPUT CHARACTERISTICS (TYPICAL)



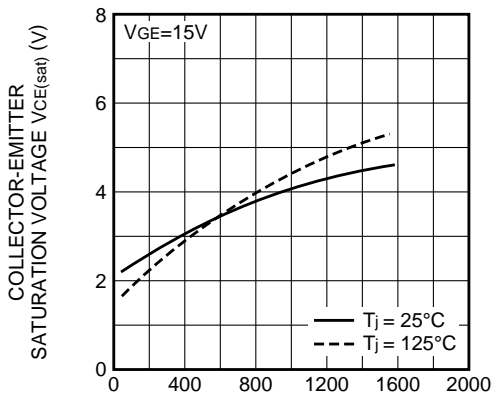
COLLECTOR-EMITTER SATURATION VOLTAGE $V_{CE(sat)}$ (V)

TRANSFER CHARACTERISTICS (TYPICAL)



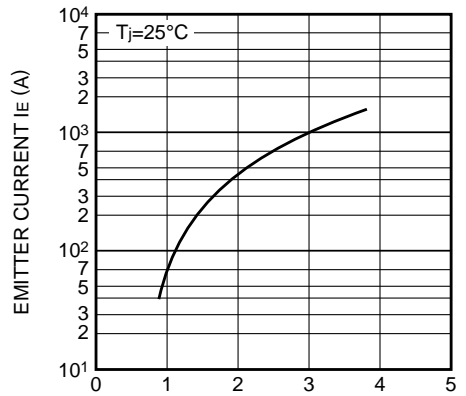
GATE-EMITTER VOLTAGE V_{GE} (V)

COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



COLLECTOR CURRENT I_c (A)

FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



EMITTER-COLLECTOR VOLTAGE V_{EC} (V)